

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L4	607	269/289r.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/12 08:07
L5	929	414/935.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/12 08:07
L6	10	("4457661" "5000113" "5037262" "5228501" "5292399" "5316278" "5326725" "5328722" "5352294" "5516367").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/04/12 08:16
L7	42	("5860640").URPN.	USPAT	OR	OFF	2005/04/12 08:17
S1	269	(451/67).CCLS.	USPAT; USOCR	OR	OFF	2004/01/30 11:08
S2	1	("5655954").PN.	USPAT; USOCR	OR	OFF	2001/05/09 12:49
S3	28	"5655954".URPN.	USPAT	OR	OFF	2001/05/09 12:38
S4	28	"5655954".URPN.	USPAT	OR	OFF	2001/05/09 12:45
S5	5	((("6149500") or ("6050884") or ("6042455") or ("5904611") or ("5885138"))).PN.	USPAT; USOCR	OR	OFF	2001/05/09 12:50
S6	2	"6293855".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2004/01/30 11:09
S7	688	451/66-67.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2004/01/30 12:49
S8	124	451/66-67.ccls. and align\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2004/01/30 14:52
S9	20322	(polish\$3 or clean\$3) adj3 wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2004/01/30 14:53
S10	645	((polish\$3 or clean\$3) adj3 wafer) same align\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2004/01/30 14:54

S11	254	((polish\$3 or clean\$3) adj3 wafer) with align\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2004/01/30 14:54
S12	10	("4350954" "5213118" "5299584" "5329732" "5333413" "5421768" "5425793" "5456627" "5498294" "5518542").PN.	USPAT	OR	OFF	2004/01/30 15:07
S13	4	((("6547639") or ("6612900") or ("6540588")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2004/01/30 17:13
S14	422	451/67.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/11 09:32
S15	21	("0034425" "20020052126" "4998021" "5081796" "5220405" "5433650" "5461007" "5492594" "5640242" "5777739" "5856871" "5872633" "5936733" "5948203" "5949927" "5958148" "5961369" "5999264" "6020264" "6319093").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/04/11 09:01
S16	7353	align\$3 adj (wafer substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/11 09:06
S17	65290	"451"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/11 09:07
S18	140	S16 and S17	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/11 09:07
S19	5	("5433651" "5492594" "5730642" "6045433" "6110011").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/04/11 09:28
S20	897	451/8.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/11 09:37

S21	11	S16 and S20	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/11 09:33
S22	703	451/9-10.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/11 09:37
S23	4	S16 and S22	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/11 09:39
S24	2715712	handling adj\$3 table	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/11 09:39
S25	3269	S16 and S24	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/11 09:53
S26	2462	S25 and wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/11 09:40
S27	2127	S16 and S24	USPAT; EPO; JPO	OR	OFF	2005/04/11 09:54
S28	2086	S16 and S24	USPAT	OR	OFF	2005/04/11 10:58
S29	868261	conductive adj\$3 pad	USPAT	OR	OFF	2005/04/11 10:09
S30	3264	conductive adj pad	USPAT	OR	OFF	2005/04/11 10:09
S31	629	S30 and wafer	USPAT	OR	OFF	2005/04/11 10:09
S32	61291	"414"/\$.ccls.	USPAT	OR	OFF	2005/04/11 10:58
S33	322	S16 and S32	USPAT	OR	OFF	2005/04/11 11:21
S34	64	414/331.01.ccls.	USPAT	OR	OFF	2005/04/11 11:23
S35	0	269/289.r.ccls.	USPAT	OR	OFF	2005/04/11 11:24
S36	324	451/67.ccls.	USPAT	OR	OFF	2005/04/11 11:27
S37	1220	451/5.ccls.	USPAT	OR	OFF	2005/04/11 11:27
S38	15	S16 and S37	USPAT	OR	OFF	2005/04/11 11:29
S39	2314	451/41.ccls.	USPAT	OR	OFF	2005/04/11 11:29
S40	38	S16 and S39	USPAT	OR	OFF	2005/04/11 12:08
S41	5	("5498199" "5498294" "5885138" "5893794" "6439962").PN.	USPAT	OR	OFF	2005/04/11 12:08